

## Final Product/Process Change Notification Document #:FPCN21837X

Issue Date: 11 August 2017

Title of Change:	Additional Final Test Location for Former Axsem Products – ON Semiconductor Carmona, Philippines.	
Proposed first ship date:	18 November 2017 or earlier after customer approval	
Contact information:	Contact your local ON Semiconductor Sales Office or < <u>Tamara.Olney@onsemi.com</u> >	
Samples:	Contact your local ON Semiconductor Sales Office	
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or < <u>Paul.Syndergaard@onsemi.com</u> >	
Type of notification:	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change. ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>	
Change Part Identification:	Affected products will be identified with date code.	
Change category:	🔲 Wafer Fab Change 🔲 Assembly Change 🖾 Test Change 🔲 Other	
Change Sub-Category(s):		
Sites Affected: Image: Ima		
Description and Purpose: AXSEM AG was acquired by ON Semiconductor in July, 2015. To expand final test capacity, ON Semiconductor Carmona, Philippine s will be added as a final test location for the below mentioned devices.		
Changes	Before Change Description	After Change Description
Tester Platform	Ocelot Inovys	uFlex Analog/Full
Tester Flow	Ambient Only	Ambient and QC Ambient
Carrier Tape	CPAK (BGA0505 CL3 22X6 L500 W12)	Advantek ML0404-AC
Reliability Data Summary: Reliability Data can be made available upon request.		
Electrical Characteristic Summary: Electrical Correlation Data can be made available upon request.		
List of Affected Standard Parts:		
Part Number		Qualification Vehicle
AX5031-1-TA05		22229-001
AX5031-1-TW30 22229-001		22229-001